



MJ P-Channel Enhancement Mode Power MOSFET

Description

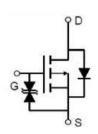
The MJ15P25JK uses advanced trench technology and design to provide excellent $R_{\text{DS}(\text{ON})}$ with low gate charge. It can be used in a wide variety of applications.

General Features

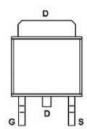
- Φ V_{DS} =-150V,I_D =-25A R_{DS(ON)} <150mΩ @ V_{GS}=-10V (Typ:120mΩ) R_{DS(ON)} <160mΩ @ V_{GS}=-4.5V (Typ:131mΩ)
- Super high dense cell design
- ◆ Advanced trench process technology
- Reliable and rugged
- ◆ High density celldesign for ultra low on-resistance

Application

◆ Portable equipment and battery powered systems







Marking and pin assignment



TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ15P25JK	MJ15P25JK	TO-252-2L	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vps	-145	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	-25	А
Drain Current-Continuous(Tc =100°C)	I _{D(100℃)}	-17	А
Pulsed Drain Current	Ідм	-140	А
Maximum Power Dissipation	Po	160	W
Derating factor		1.3	W/°C
Operating Junction and Storage Temperature Range	TJ ,Tstg	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	0.8	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2)	RөJA	40	°C/W





Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	'	1	1			
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =-250μA	-145	-155	-	V
Zero Gate Voltage Drain Current	loss	V _{DS} =-145V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±10	μA
On Characteristics (Note 3)	,					
Gate Threshold Voltage	V _G S(th)	V _{DS} =V _{GS} ,I _D =-250μA	-1.5	-1.9	-3	V
Dunin Course On Chata Desistance	D.	Vgs=-10V, Ip=-20A	-	120	150	mΩ
Drain-Source On-State Resistance	Rds(on)	V _{GS} =-4.5V, I _D =-20A	-	131	160	mΩ
Forward Transconductance	grs	V _{DS} =-5V,I _D =-20A	5	-	-	S
Dynamic Characteristics (Note 4)	-	1				
Input Capacitance	Ciss		-	7650	-	PF
Output Capacitance	Coss	V _{DS} =-75V,V _{GS} =0V F=1.0MHz	-	148	-	PF
Reverse Transfer Capacitance	Crss	•	_	131	-	PF
Switching Characteristics (Note 4)	·					
Turn-on Delay Time	t _{d(on)}		_	17	-	nS
Turn-on Rise Time	tr	V _{DD} =-75V,I _D =-20A	-	80	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-10V,R _{GEN} =9.1Ω	_	45	-	nS
Turn-Off Fall Time	tr	-	_	65	-	nS
Total Gate Charge	Qg		-	137	-	nC
Gate-Source Charge	Qgs	V _{DS} =-75V,I _D =-20A V _{GS} =-10V	_	25	_	nC
Gate-Drain Charge	Qgd		_	28	-	nC
Drain-Source Diode Characteristics				<u> </u>	<u> </u>	<u> </u>
Diode Forward Voltage (Note 3)	Vsp	V _{GS} =0V,I _S =-25A	_	-	-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-25	А
Reverse Recovery Time	trr	T1-25°C Ic- 25^	-	90	_	nS
Reverse Recovery Charge	Qrr	TJ=25°C, IF=-25A di/dt=100A/µs (Note 3)	_	105		nC

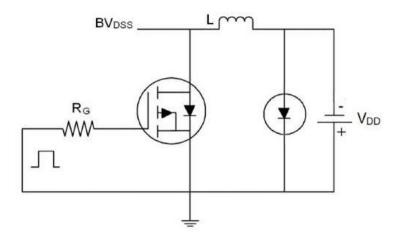
Notes:

- Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② The value of Reja is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with Ta =25°C. The the maximum allowed junction temperature of 150°C
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production
- \odot EAS condition: Tj=25°C,VDD=-75V,VG=-10V,L=0.5mH,Rg=25 Ω

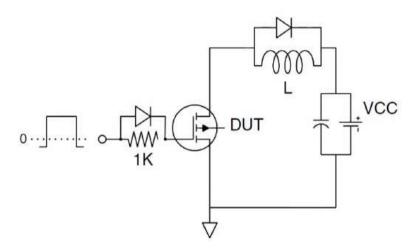




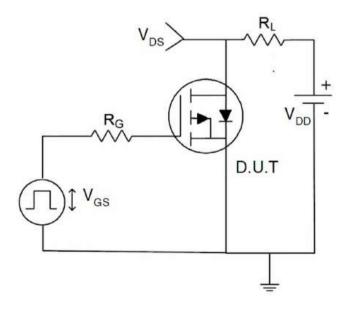
Test circuit



Eas test Circuit



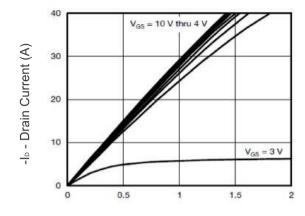
Gate charge test Circuit



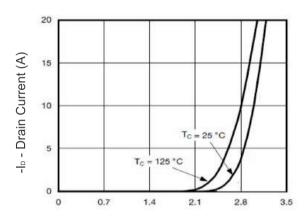
Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (Curves)



-Vds Drain-Source Voltage (V)
Figure 1 Output Characteristics



-Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

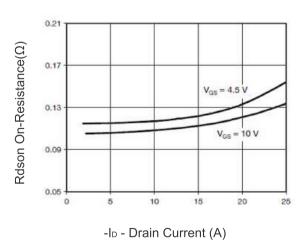
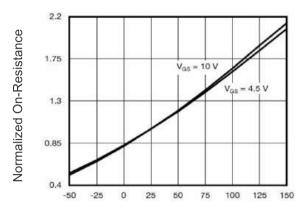
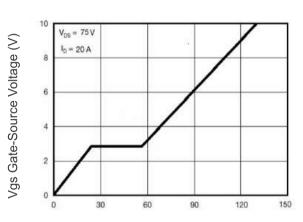


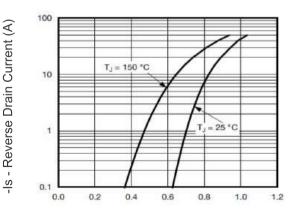
Figure 3 Rdson- Drain Current



TJ -Junction Temperature(°C)
Figure 4 Rdson-Junction Temperature

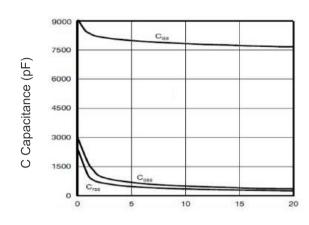


Qg Gate Charge (nC)
Figure 5 Gate Charge



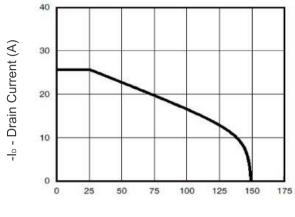
-Vsd Source-Drain Voltage (V)
Figure 6 Source- Drain Diode Forward





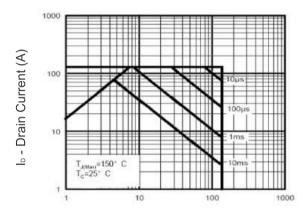
-Vds Drain-Source Voltage (V)

Figure 7 Capacitance vs Vds



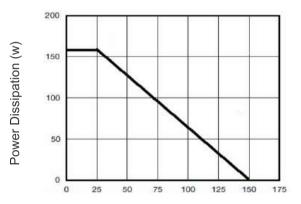
Tc Case Temperature(°C)

Figure 9 Drain Current vs Case Temperature



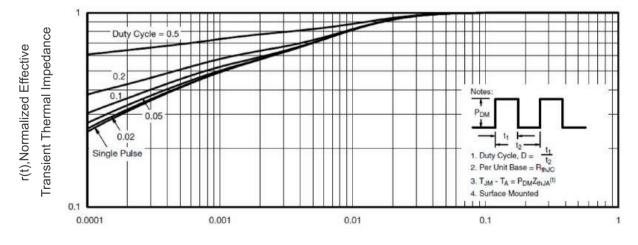
-Vds Drain-Source Voltage (V)

Figure 8 Safe Operation Area



T_J -Junction Temperature(°C)

Figure 10 Power De-rating



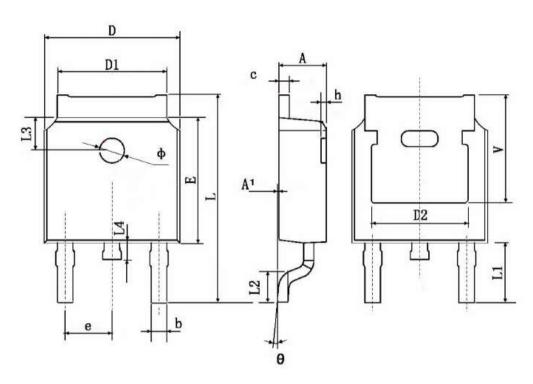
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimension	s In Inches
	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.8	30 TYP.	0.190 TYP.	
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600	TYP.	0.063	TYP.
L4	0.600	1.000	0.024	0.039
Ф	1.100	1.300	0.043	0.051
θ	0°	8°	0.	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211	TYP.





Attention:

Any and all MJ power products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your MJ power representative nearest you before using any MJ power products described or contained herein in such applications.

MJ power assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all MJ power products described or contained herein.

Specifications of any and all MJ power products described or contained herein stipulate the erformance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

MJ power Semiconductor CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

In the event that any or all MJ power products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.

No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or therwise, without the prior written permission of MJ power Semiconductor CO.,LTD.

Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. MJ power believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the MJ power product that you intend to use.

This catalog provides information as of Sep.2010. Specifications and information herein are subject to change without notice.